

Dual N-Channel 100-V (D-S) MOSFET

CHARACTERISTICS

- N-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS

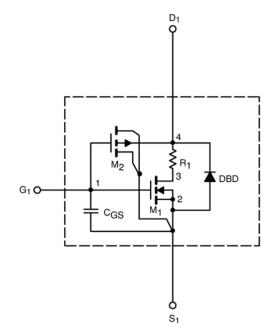
- Apply for both Linear and Switching Application
- Accurate over the -55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

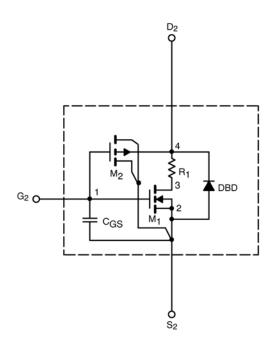
DESCRIPTION

The attached spice model describes the typical electrical characteristics of the n-channel vertical DMOS. The subcircuit model is extracted and optimized over the -55 to 125° C temperature ranges under the pulsed 0-V to 10-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

SUBCIRCUIT MODEL SCHEMATIC





This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.



Parameter	Symbol	Test Condition	Simulated Data	Measured Data	Unit
Static				-	
Gate Threshold Voltage	V _{GS(th)}	V_{DS} = V_{GS} , I_D = 250 μ A	2.6		V
On-State Drain Current ^a	I _{D(on)}	$V_{\text{DS}} \geq 5$ V, V_{GS} = 10 V	29		А
Drain-Source On-State Resistance ^a	۲ _{DS(on)}	V_{GS} = 10 V, I _D = 2.5 A	0.16	0.16	Ω
		V_{GS} = 6 V, I_{D} = 2.3 A	0.18	0.19	
Forward Transconductance ^a	g _{fs}	V_{DS} = 10 V, I _D = 2.5 A	4.8	5.3	S
Diode Forward Voltage ^a	V _{SD}	$I_{\rm S}$ = 2.2 A, $V_{\rm GS}$ = 0 V	0.73	0.8	V
Dynamic ^b				-	
Total Gate Charge	Qg	$V_{\rm DS}$ = 50 V, $V_{\rm GS}$ = 10 V, $I_{\rm D}$ = 2.5 A	4.8	5.2	nC
Gate-Source Charge	Q _{gs}		1.1	1.1	
Gate-Drain Charge	Q _{gd}		1.9	1.9	
Turn-On Delay Time	t _{d(on)}	$\label{eq:V_DD} \begin{array}{l} \text{V}_{\text{DD}} \text{ = 50 V, } \text{R}_{\text{L}} \text{ = 50 } \Omega \\ \text{I}_{\text{D}} \cong \text{1 A, } \text{V}_{\text{GEN}} \text{ = 4.5 V, } \text{R}_{\text{G}} \text{ = 6 } \Omega \end{array}$	7	7	ns
Rise Time	tr		14	11	
Turn-Off Delay Time	$t_{\text{d(off)}}$		8	8	
Fall Time	t _f		13	11	
Source-Drain Reverse Recovery Time	trr	I _F = 2.2 A, di/dt = 100 A/μs	32	40	

Notes

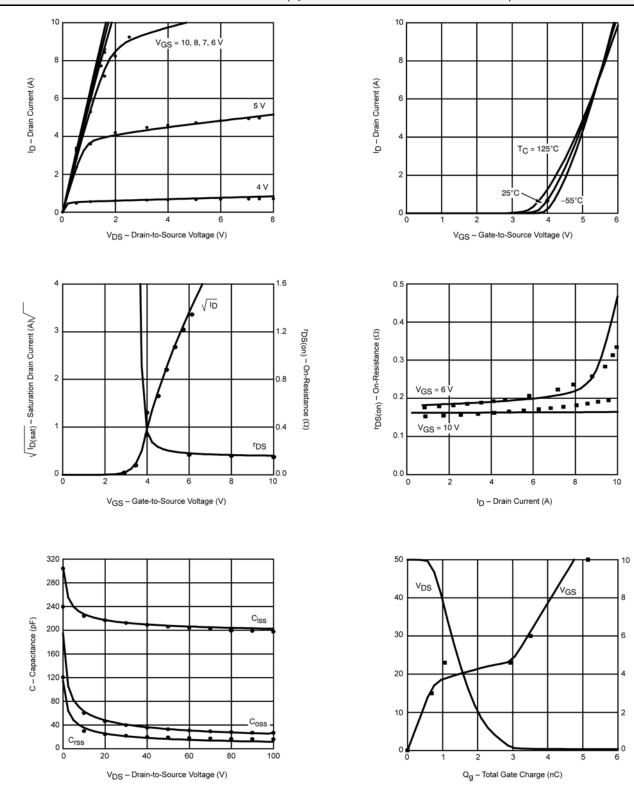
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2%. b. Guaranteed by design, not subject to production testing.



SPICE Device Model Si7922DN

Vishay Siliconix

COMPARISON OF MODEL WITH MEASURED DATA (TJ=25°C UNLESS OTHERWISE NOTED)



Note: Dots and squares represent measured data



Vishay

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